

## Features

- Trench MOSFET Technology
- Moisture Sensitivity Level 3
- Halogen Free. "Green" Device<sup>(Note1)</sup>
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

## Maximum Ratings

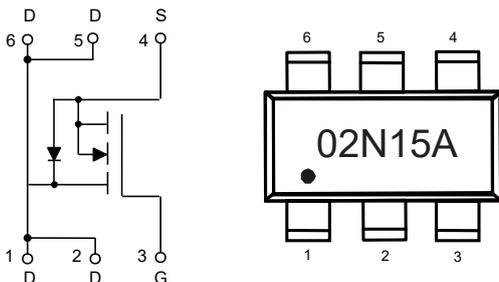
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 70°C/W Junction to Ambient<sup>(Note2)</sup>

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage	$V_{DS}$	150	V	
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V	
Continuous Drain Current	$I_D$	$T_A=25^\circ\text{C}$	2	A
		$T_A=100^\circ\text{C}$	1.3	A
Pulsed Drain Current <sup>(Note3)</sup>	$I_{DM}$	8	A	
Total Power Dissipation <sup>(Note4)</sup>	$P_D$	1.8	W	

Note:

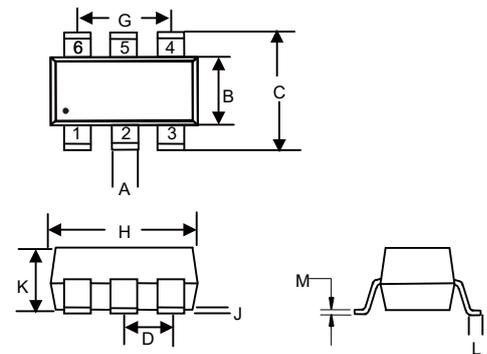
1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ .
3. Repetitive rating; pulse width limited by max. junction temperature.
4.  $P_D$  is based on max. junction temperature, using junction-ambient thermal resistance.

## Internal Structure and Marking Code



# N-CHANNEL MOSFET

## SOT23-6L



DIM	MIN DIMENSIONS				NOTE
	INCHES		MM		
	MAX	MIN	MAX		
A	0.012	0.020	0.30	0.50	
B	0.051	0.070	1.30	1.80	
C	0.087	0.126	2.20	3.20	
D	0.037		0.95		TYP.
G	0.074		1.90		TYP.
H	0.106	0.122	2.70	3.10	
J	0.002	0.006	0.05	0.15	
K	0.030	0.051	0.75	1.30	
L	0.012	0.024	0.30	0.60	
M	0.003	0.008	0.08	0.22	

**Electrical Characteristics @ 25°C (Unless Otherwise Specified)**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	150			V
Gate-Source Leakage Current	$I_{GSS}$	$V_{DS}=0V, V_{GS}=\pm 20V$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=150V, V_{GS}=0V$			1	$\mu A$
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.0	1.8	2.5	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=2A$		214	290	m $\Omega$
		$V_{GS}=8V, I_D=1.5A$		215	300	
Forward Transconductance	$g_{fs}$	$V_{DS}=50V, I_D=1A$		13		S
Gate Resistance	$R_g$	F=1 MHz, Open drain		2.4		$\Omega$
<b>Diode Characteristics</b>						
Continuous Body Diode Current	$I_S$				2	A
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=1A$			1.3	V
Reverse Recovery Time	$t_{rr}$	$I_F=2A, dI_F/dt=100A/\mu s$		28		ns
Reverse Recovery Charge	$Q_{rr}$				33	
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=100V, V_{GS}=0V, f=1MHz$		666		pF
Output Capacitance	$C_{oss}$			15		
Reverse Transfer Capacitance	$C_{rss}$			10		
Total Gate Charge	$Q_g$	$V_{DS}=75V, V_{GS}=10V, I_D=2A$		14		nC
Gate-Source Charge	$Q_{gs}$			1.9		
Gate-Drain Charge	$Q_{gd}$			3.5		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=75V, V_{GS}=10V, R_{GEN}=4.5\Omega, I_{DS}=2A$		5.9		ns
Turn-On Rise Time	$t_r$			2.5		
Turn-Off Delay Time	$t_{d(off)}$			18		
Turn-Off Fall Time	$t_f$			3.3		

## Curve Characteristics

Fig. 1 - Typical Output Characteristics

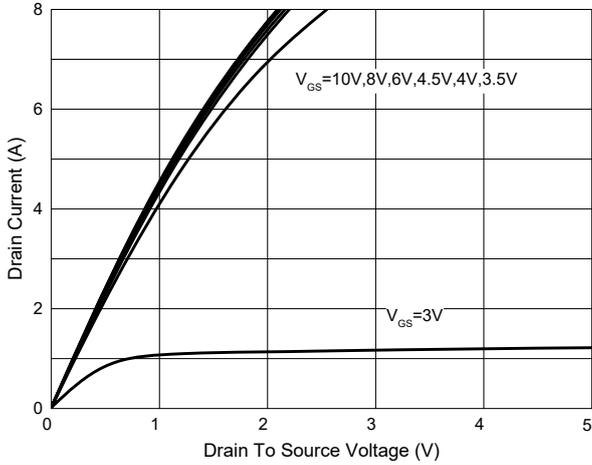


Fig. 2 - Transfer Characteristics

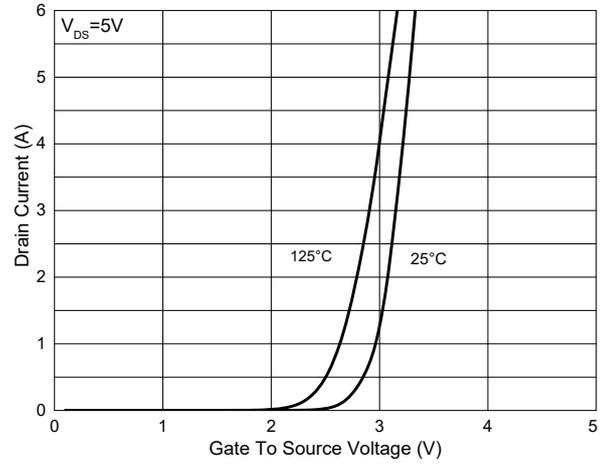


Fig. 3 -  $R_{DS(ON)} - V_{GS}$

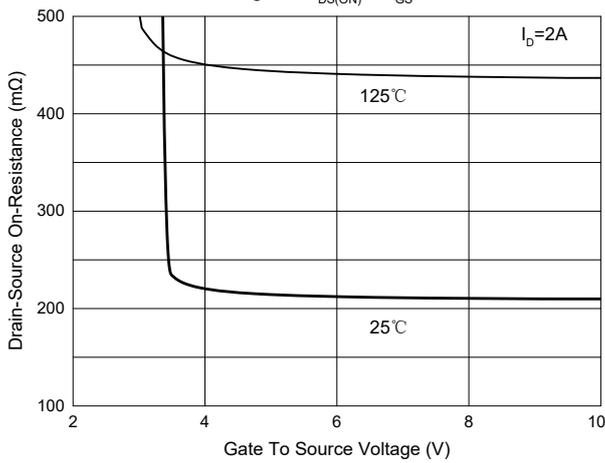


Fig. 4 -  $R_{DS(ON)} - I_D$

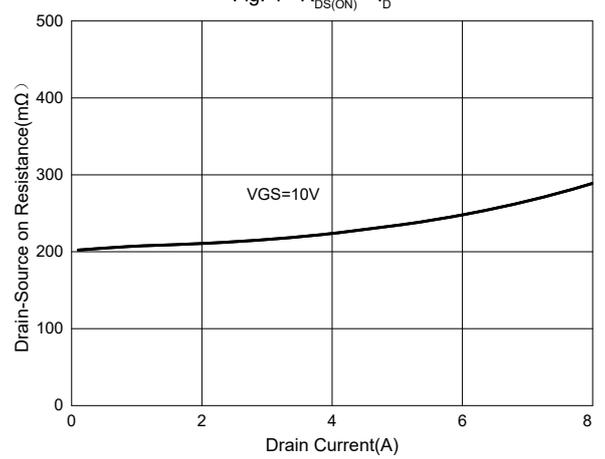


Fig. 5 - Capacitance Characteristics

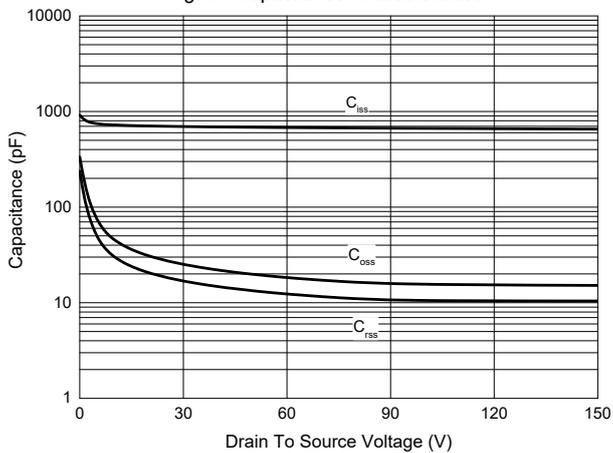
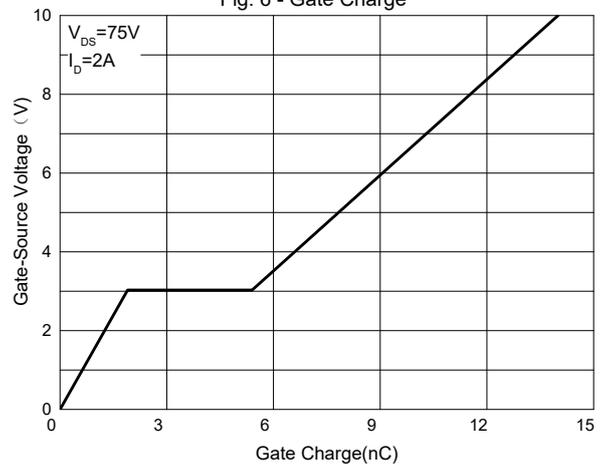
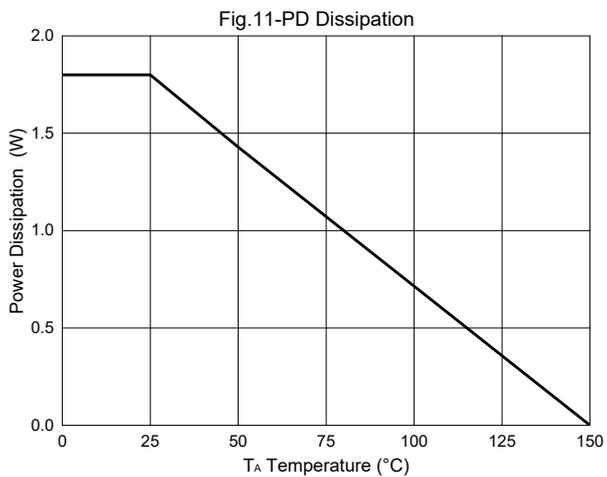
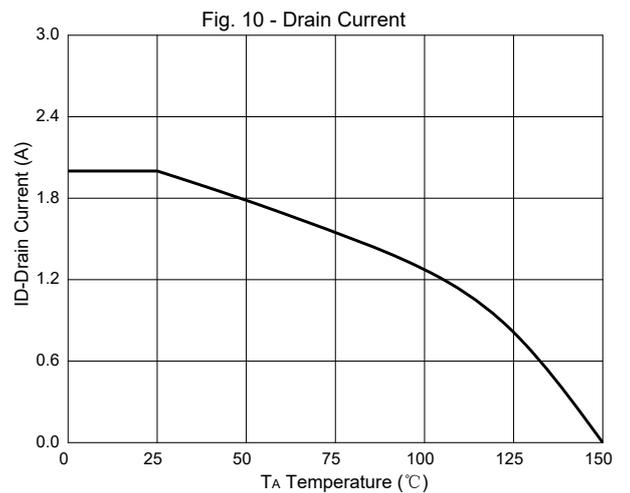
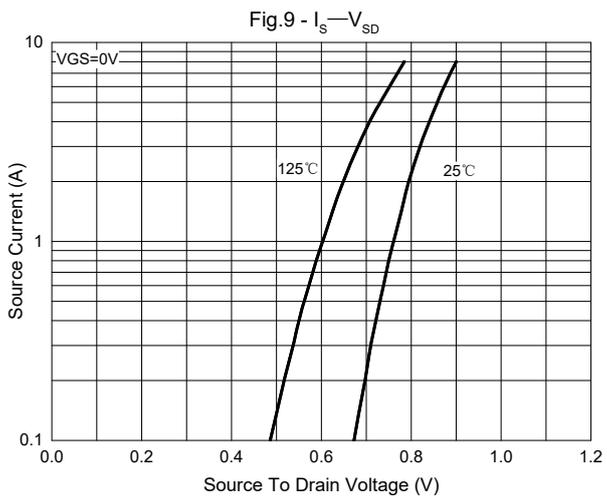
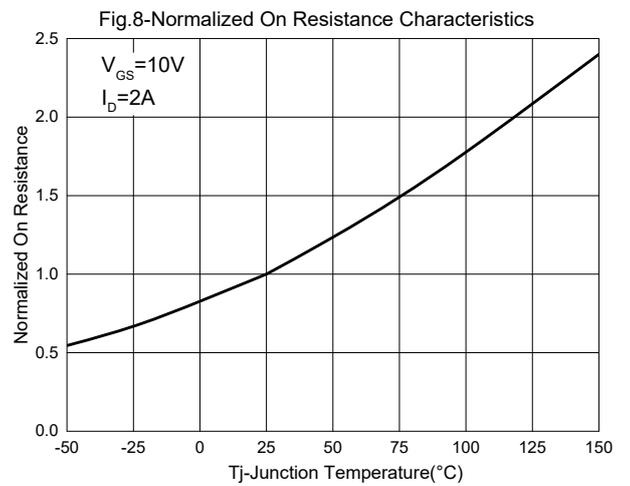
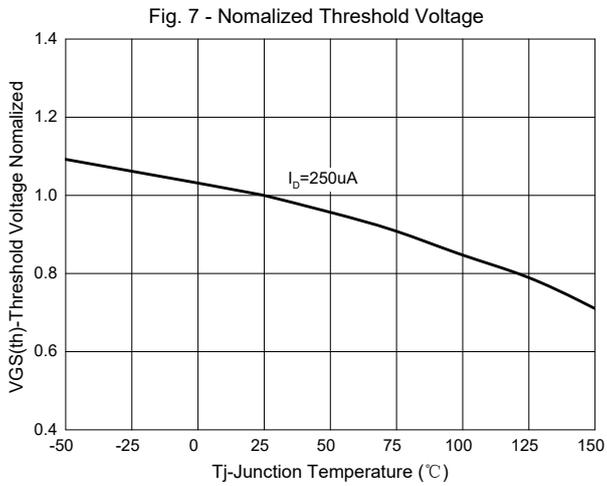


Fig. 6 - Gate Charge



## Curve Characteristics



## Curve Characteristics

Fig. 12 - Safe Operation Area

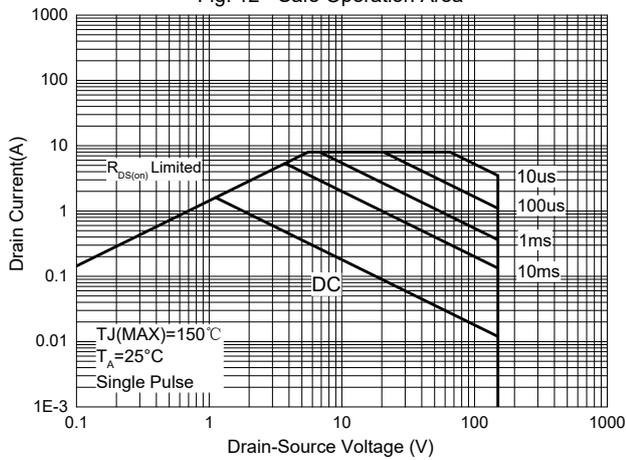
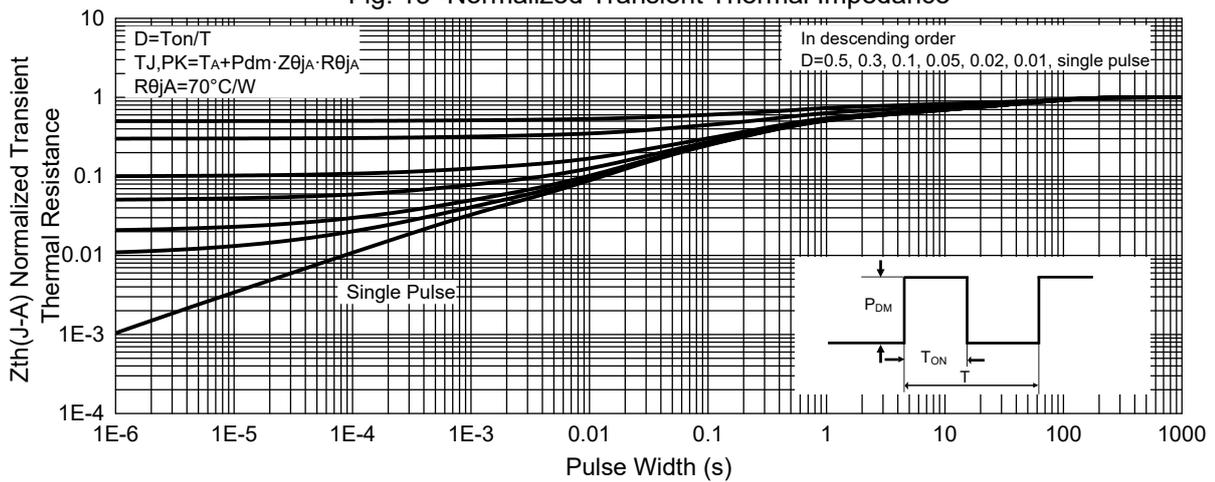


Fig. 13 - Normalized Transient Thermal Impedance



## Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 3Kpcs/Reel

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